









PRODUCT DATASHEET



- ► PLCC4 SMD Top View
- ➤ 2121 1.9t Series
- ► Red / Green / Blue

NOM68S44BF





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FEATURES (Red/Green/Blue):

- Package: PLCC4 Common Anode Top View SMD Package
- Forward Current: 15/8/5mA*
- Forward Voltage (typ.): 2.0/2.7/2.7V
- Luminous Intensity (typ.): 350/500/52mcd@15/8/5mA
- Colour: Red/Green/Blue
- Dominant Wavelength (typ.): 622/525/470nm
- Viewing Angle: 120°
- **Materials:**
 - Die: AlGaInP/InGaN/InGaN
 - Resin: Epoxy (Water Diffused)
- Operating Temperature: -30~+85°C
- Storage Temperature: -40~+85°C
- ESD: 2000/1000/1000V (HBM)
- **Grouping Parameters:**
 - Forward Voltage
 - **Luminous Intensity**
 - **Dominant Wavelength**
- Soldering Methods: IR Reflow soldering
- MSL: Level 5a according to J-STD020
- Packing: 8mm tape with max.8,000pcs/reel, ø328mm (13'')* In the order of Red/Green/Blue

APPLICATIONS:

- **Decoration Lighting**
- **Dashboards Backlight**
- Indicator
- **Light Pipe Application**
- 3C Consumer Goods
- **RGB LED Display**
- **Gaming Devices**



CHARACTERISTICS:

Absolute Maximum Characteristics (T_a=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	25/25/20 ¹	mA
Peak Forward Current (duty factor 10%, 1kHz) ²	I _{FP}	50/50/50	mA
Power Dissipation	PD	60/82.5/65	mW
Reverse Voltage	VR	5/5/5	V
Reverse Current @5V	I _R	10/10/10	μΑ
Electrostatic Discharge (HBM)	ESD	2000/1000/1000	V
Operating Temperature	T _{OPR}	-30~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C

^{1.} In the order of Red/Green/Blue.

^{2.} Derate linearly as shown in derating curve.



Electrical & Optical Characteristics (T_a=25°C)

Parameter	Symbol	Min.	Values Typ.	Max.	Unit	Test Condition
Red - Forward Voltage	V _F	1.6	2.0	2.4	V	
Red - Luminous Intensity ¹	l _V	230	350		mcd	
Red - Peak Wavelength	λ_{P}		632		nm	I⊧=15mA
Red - Dominant Wavelength ²	λ_{D}		622		nm	
Red - Spectral Line Half Width	Δλ		15		nm	
Green - Forward Voltage	V _F	2.4	2.7	3.3	V	
Green - Luminous Intensity	lv	350	500		mcd	
Green - Peak Wavelength	W _P		520		nm	I _F =8mA
Green - Dominant Wavelength	λ_{D}		525		nm	
Green - Spectral Line Half Width	Δλ		25		nm	
Blue - Forward Voltage	VF	2.4	2.7	3.3	V	
Blue - Luminous Intensity	lv	35	52		mcd	
Blue - Peak Wavelength	W _P		468		nm	I _F =5mA
Blue - Dominant Wavelength	λ_{D}		470		nm	
Blue - Spectral Line Half Width	Δλ		19		nm	
Viewing Angle ³	2θ _{1/2}		120		deg	I _F =15/8/5mA

^{1.} Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

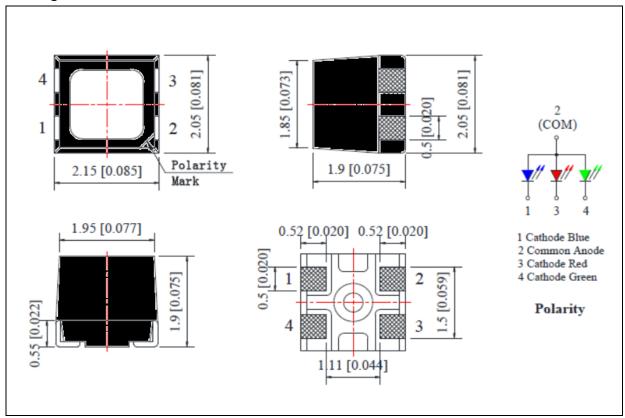
^{2.} The dominant wavelength (λ_d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the colour of the device.

^{3.} $2\theta_{1/2}$ is the o-axis angle where the luminous intensity is 1/2 the peak intensity.



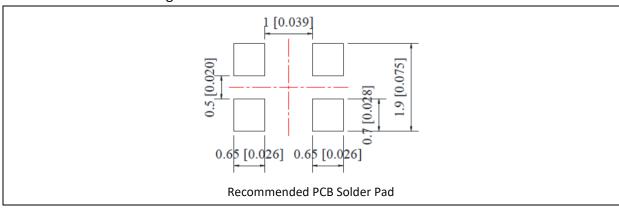
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.25mm, unless otherwise noted.
- 3. Protruded resin under flange is 1.00mm max.

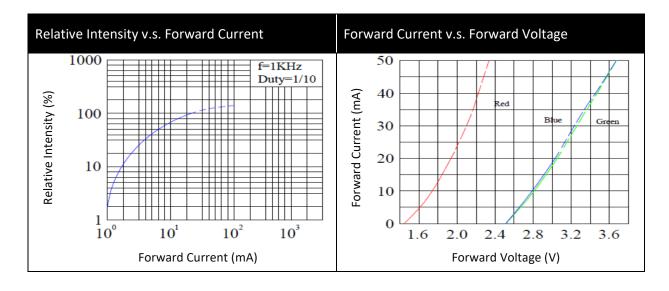
Recommended Soldering Pad Dimension:

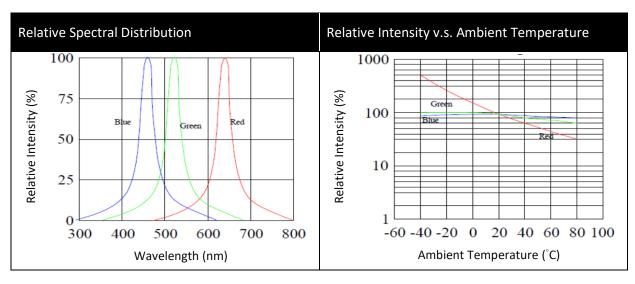


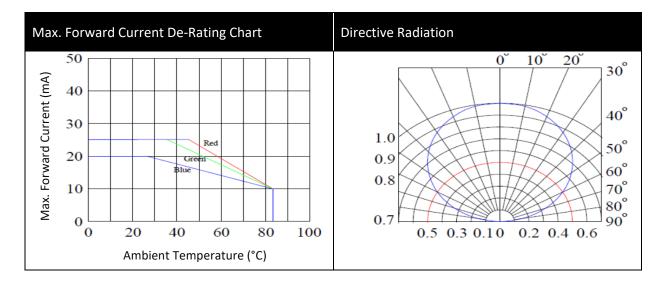
- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance ± 0.5 °.
- 3. Suggested stencil t=0.12mm.



ELECTRO-OPTICAL CHARACTERISTICS:





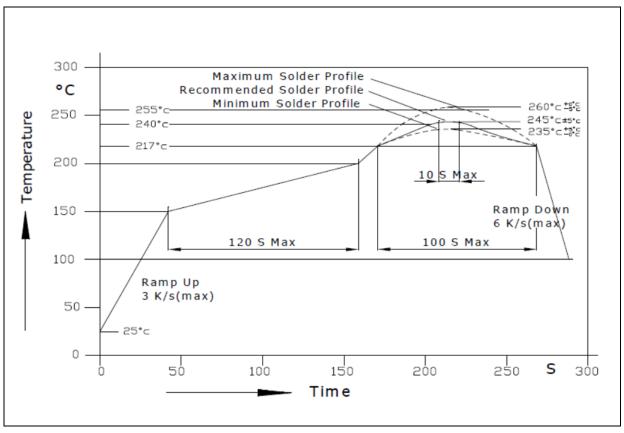


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RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



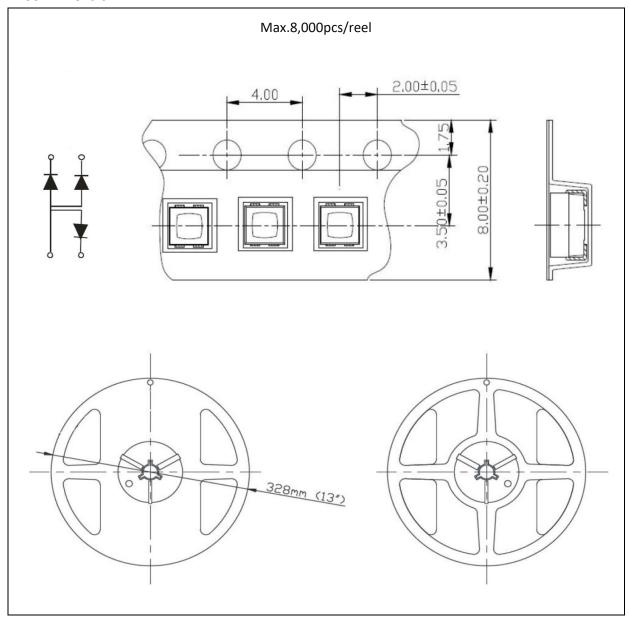
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature is 240°C; the maximum soldering temperature should be limited to 250°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 24 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

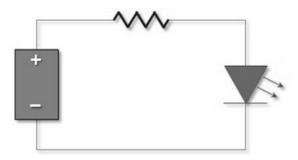
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 65±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	16/12/2024	Datasheet set-up.